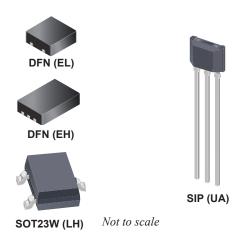


#### **FEATURES AND BENEFITS**

- AEC-Q100 automotive qualified
- Micropower operation
- Operation with north or south pole
- 2.5 to 3.5 V battery operation
- Chopper stabilized
  - □ Superior temperature stability
  - □ Extremely low switch point drift
  - ☐ Insensitive to physical stress
- High ESD protection
- · Solid-state reliability
- · Small size
- · Easily manufacturable with magnet pole independence

#### PACKAGES:



#### **DESCRIPTION**

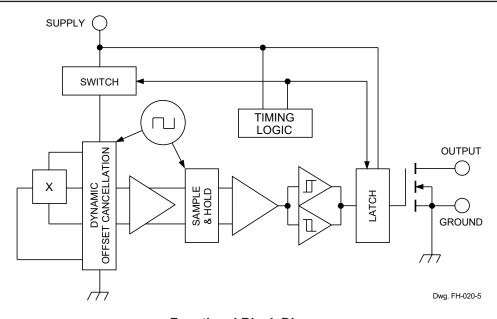
The A3211 and A3212 integrated circuits are ultrasensitive, pole independent Hall-effect switches with latched digital output. These devices are especially suited for operation in battery-operated, hand-held equipment such as cellular and cordless telephones, pagers, and palmtop computers. A 2.5 to 3.5 V operation and a unique clocking scheme reduce the average operating power requirements to less than 15  $\mu W$  with a 2.75 V supply.

Unlike other Hall-effect switches, either a north or south pole of sufficient strength will turn the output on in the A3212, and in the absence of a magnetic field, the output is off. The A3211 provides an inverted output. The polarity independence and minimal power requirements allow these devices to easily replace reed switches for superior reliability and ease of manufacturing, while eliminating the requirement for signal conditioning.

Improved stability is made possible through chopper stabilization (dynamic offset cancellation), which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress.

This device includes on a single silicon chip a Hall-voltage generator, small-signal amplifier, chopper stabilization, a latch, and a MOSFET output. Advanced CMOS processing is used to take advantage of low-voltage and low-power

Continued on next page....



**Functional Block Diagram** 

#### **DESCRIPTION** (continued)

requirements, component matching, very low input-offset errors, and small component geometries.

Four package styles provide magnetically optimized solutions for most applications. Miniature low-profile surface-mount package types EH and EL (0.75 and 0.50 mm nominal height) are leadless, LH is a 3-pin low-profile SMD, and UA is a three-pin SIP for throughhole mounting. Packages are lead (Pb) free (suffix, -T) with 100% matte-tin-plated leadframes.

#### **SPECIFICATIONS**

#### **SELECTION GUIDE**

| Part Number            | Packing <sup>[1]</sup>       | Package                                 | Ambient Temperature T <sub>A</sub> (°C) | State in<br>Magnetic Field |
|------------------------|------------------------------|---|---|----------------------------|
| A3211EEHLT-T [2][3][4] | 3000 pieces per reel         | 2 mm × 3 mm, 0.75 mm nominal height DFN |   |                            |
| A3211EELLT-T [2][4][5] | 3000 pieces per reel         | 2 mm × 2 mm, 0.50 mm nominal height DFN | 40.45.05                                | 0#                         |
| A3211ELHLT-T [4]       | 3000 pieces per reel         | 3-pin surface mount SOT23W              | 40 to 85                                | Off                        |
| A3211ELHLX-T [4]       | 10000 pieces per 13-in. reel | 3-pin surface mount SOT23W              |   |                            |
| A3212EEHLT_T [2][3]    | 3000 pieces per reel         | 2 mm × 3 mm, 0.75 mm nominal height DFN |   | On                         |
| A3212EELLT_T [2][5]    | 3000 pieces per reel         | 2 mm × 2 mm, 0.50 mm nominal height DFN |   |                            |
| A3212ELHLT-T           | 3000 pieces per reel         | 3-pin surface mount SOT23W              | -40 to 85                               |                            |
| A3212ELHLX-T           | 10000 pieces per 13-in. reel | 3-pin surface mount SOT23W              |   |                            |
| A3212EUA-T             | 500 pieces per bulk bag      | SIP-3 through hole                      |   |                            |
| A3212LLHLT-T           | 3000 pieces per reel         | 3-pin surface mount SOT23W              |   |                            |
| A3212LLHLX-T           | 10000 pieces per 13-in. reel | 3-pin surface mount SOT23W              | -40 to 150                              |                            |
| A3212LUA-T             | 500 pieces per bulk bag      | SIP-3 through hole                      |   |                            |

<sup>&</sup>lt;sup>1</sup> Contact Allegro for additional packaging and handling options.

<sup>&</sup>lt;sup>5</sup> Variant is in production but has been determined to be LAST TIME BUY. This classification indicates that the product is obsolete and notice has been given. Sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because of obsolescence in the near future. Samples are no longer available. Date of status change: September 1, 2016.



#### **ABSOLUTE MAXIMUM RATINGS**

| Characteristic Symb                           |                      | Notes   | Rating     | Units |
|---|----------------------|---------|------------|-------|
| Supply Voltage V <sub>DD</sub>                |                      |         | 5          | V     |
| Magnetic Flux Density                         | В                    |         | Unlimited  | G     |
| Output Off Voltage                            | V <sub>OUT</sub>     |         | 5          | V     |
| Output Current                                | I <sub>OUT</sub>     |         | 1          | mA    |
| On a making of Amala is not Tamana a material | _                    | Range E | -40 to 85  | °C    |
| Operating Ambient Temperature                 | T <sub>A</sub>       | Range L | -40 to 150 | °C    |
| Maximum Junction Temperature                  | T <sub>J</sub> (max) |         | 165        | °C    |
| Storage Temperature                           | T <sub>stg</sub>     |         | -65 to 170 | °C    |



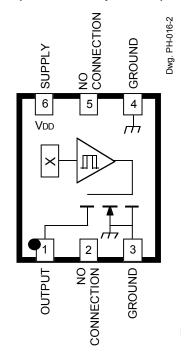
<sup>&</sup>lt;sup>2</sup> Allegro products sold in DFN package types are not intended for automotive applications.

<sup>&</sup>lt;sup>3</sup> Variant is no longer in production. The device should not be purchased for new design applications. Samples are no longer available. Date of status change: June 1, 2015 (A3212EEHLT-T), December 1, 2015 (A3211EEHLT-T).

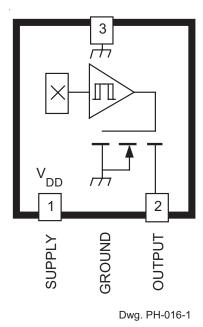
<sup>&</sup>lt;sup>4</sup> For automotive sales, please contact the field applications engineer.

#### **PINOUT DRAWINGS**

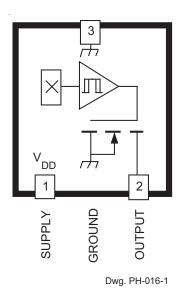
### Package Suffix 'EH' Pinning (Leadless Chip Carrier)



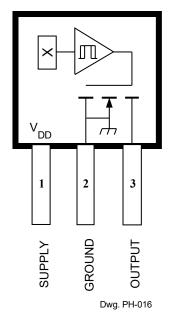
Package Suffix 'LH' Pinning (SOT23W)



Package Suffix 'EL' Pinning (Leadless Chip Carrier)



Package Suffix 'UA' Pinning (SIP)



Pinning is shown viewed from branded side.



# A3211 and A3212

### **Micropower Ultrasensitive Hall-Effect Switches**

#### **ELECTRICAL CHARACTERISTICS:** Over operating voltage and temperature range (unless otherwise specified)

| Ob a wasta wistin      | Symbol               | Test Conditions                                   | Limits |       |      |       |
|------------------------|----------------------|---|--------|-------|------|-------|
| Characteristic         |                      |   | Min.   | Тур.* | Max. | Units |
| Supply Voltage Range   | V <sub>DD</sub>      | Operating   | 2.5    | 2.75  | 3.5  | V     |
| Output Leakage Current | I <sub>OFF</sub>     | V <sub>OUT</sub> = 3.5 V, Output off              | _      | <1.0  | 1.0  | μA    |
| Output On Voltage      | V <sub>OUT</sub>     | I <sub>OUT</sub> = 1 mA, V <sub>DD</sub> = 2.75 V | _      | 100   | 300  | mV    |
| Awake Time             | t <sub>awake</sub>   |   | _      | 45    | 90   | μs    |
| Period                 | t <sub>period</sub>  |   | _      | 45    | 90   | ms    |
| Duty Cycle             | d.c.                 |   | _      | 0.1   | _    | %     |
| Chopping Frequency     | f <sub>C</sub>       |   | _      | 340   | _    | kHz   |
|                        | I <sub>DD(EN)</sub>  | Chip awake (enabled)                              | _      | _     | 2.0  | mA    |
| Supply Current         | I <sub>DD(DIS)</sub> | Chip asleep (disabled)                            | _      | _     | 8.0  | μA    |
| Supply Current         |                      | V <sub>DD</sub> = 2.75 V                          | _      | 5.1   | 10   | μA    |
|                        | I <sub>DD(AVG)</sub> | V <sub>DD</sub> = 3.5 V                           | _      | 6.7   | 10   | μA    |

 $<sup>^{\</sup>star}$  Typical data is at T<sub>A</sub> = 25°C and V<sub>DD</sub> = 2.75 V, and is for design information only.

### **A3211** and A3212

### **Micropower Ultrasensitive Hall-Effect Switches**

#### A3211 MAGNETIC CHARACTERISTICS: Over operating voltage range (unless otherwise specified)

| Characteristic Sy | Councile al  | Took Constitutions   | Limits |      |      |       |
|-------------------|--|--|--------|------|------|-------|
|                   | Symbol   | Symbol Test Conditions   |        | Тур. | Max. | Units |
| Over Temperature  | Over Temperature Range E: T <sub>A</sub> = -40°C to 85°C |  |        |      |      |       |
| Operate Points    | B <sub>OPS</sub>   | South pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = High (Output Off) | _      | 37   | 55   | G     |
|                   | B <sub>OPN</sub>   | North pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = High (Output Off) | -55    | -40  | _    | G     |
| Release Points    | B <sub>RPS</sub>   | South pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = Low (Output On)   | 10     | 31   | _    | G     |
|                   | B <sub>RPN</sub>   | North pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = Low (Output On)   | -      | -34  | -10  | G     |
| Hysteresis        | B <sub>HYS</sub>   | B <sub>OPx</sub> - B <sub>RPx</sub>  |        | 5.9  | _    | G     |

- 1. Negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.
- 2.  $B_{OPX}$  = operate point (output turns off);  $B_{RPX}$  = release point (output turns on). 3. Typical Data is at  $T_A$  = +25°C and  $V_{DD}$  = 2.75 V and is for design information only. 4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).

#### A3212 MAGNETIC CHARACTERISTICS: Over operating voltage range (unless otherwise specified)

| Characteristic  | Cumbal                 | Took Conditions  | Limits                                  |      |      |       |
|---|------------------------|--|---|------|------|-------|
| Characteristic  | Symbol                 | Test Conditions  |   | Тур. | Max. | Units |
| Over Temperature R  | ange E: T <sub>A</sub> | = -40°C to 85°C  |   |      |      |       |
| Operate Points  | B <sub>OPS</sub>       | South pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = Low (Output On)   | _                                       | 37   | 55   | G     |
| Operate Points  | B <sub>OPN</sub>       | North pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = Low (Output On)   | -55                                     | -40  | _    | G     |
| Release Points  | B <sub>RPS</sub>       | South pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = High (Output Off) | 10                                      | 31   | -    | G     |
| Release Points  B <sub>RPN</sub>                          |                        | North pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = High (Output Off) | _                                       | -34  | -10  | G     |
| Hysteresis  | B <sub>HYS</sub>       | B <sub>OPx</sub> - B <sub>RPx</sub>  | B <sub>OPx</sub> - B <sub>RPx</sub>   - |      | _    | G     |
| Over Temperature Range L: T <sub>A</sub> = -40°C to 150°C |                        |  |   |      |      |       |
| Operate Deinte  | B <sub>OPS</sub>       | South pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = Low (Output On)   | _                                       | 37   | 65   | G     |
| Operate Points  | B <sub>OPN</sub>       | North pole to branded side; B > B <sub>OP</sub> , V <sub>OUT</sub> = Low (Output On)   | -65                                     | -40  | _    | G     |
| Delegge Deinte  | B <sub>RPS</sub>       | South pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = High (Output Off) | 10                                      | 31   | _    | G     |
| Release Points  | B <sub>RPN</sub>       | North pole to branded side; B < B <sub>RP</sub> , V <sub>OUT</sub> = High (Output Off) | -                                       | -34  | -10  | G     |
| Hysteresis  | B <sub>HYS</sub>       | $ B_{OPx} - B_{RPx} $ - 5.9 -  |   | _    | G    |       |

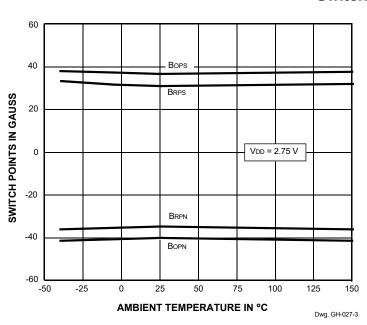
NOTES: 1. Negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.

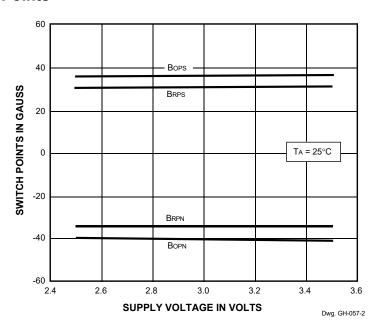
- 2.  $B_{OPx}$  = operate point (output turns on);  $B_{RPx}$  = release point (output turns off). 3. Typical Data is at  $T_A$  = +25°C and  $V_{DD}$  = 2.75 V and is for design information only. 4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).



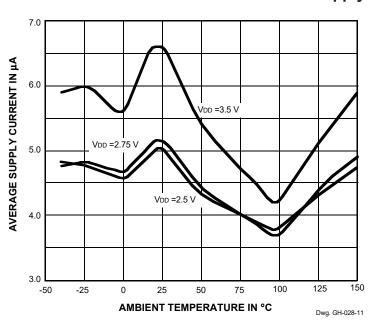
#### TYPICAL OPERATING CHARACTERISTICS

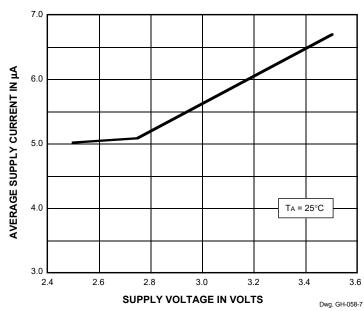
#### **Switch Points**





### **Supply Current**

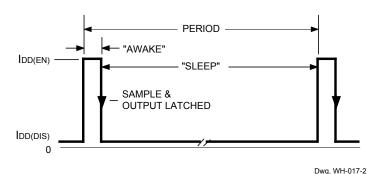


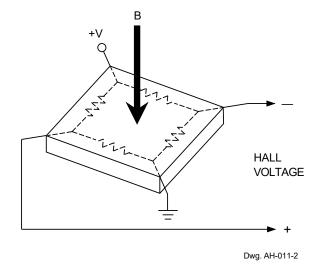


#### **FUNCTIONAL DESCRIPTION**

#### Low Average Power

Internal timing circuitry activates the IC for 45  $\mu$ s and deactivates it for the remainder of the period (45 ms). A short "awake" time allows for stabilization prior to the sampling and data latching on the falling edge of the timing pulse. The output during the "sleep" time is latched in the last sampled state. The supply current is not affected by the output state.

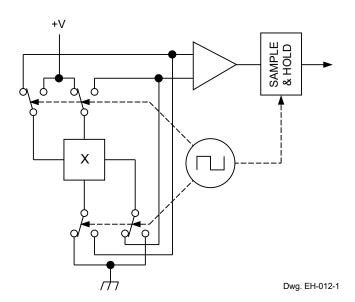




### **Chopper-Stabilized Technique**

The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. The chopper-stabilizing technique cancels the mismatching of the resistor circuit by changing the direction of the current flowing through the Hall plate using CMOS switches and Hall voltage measurement taps, while maintaing the Hall-voltage signal that is induced by the external magnetic flux. The signal is then captured by a sample-and-hold circuit and further processed using low-offset bipolar circuitry. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. A relatively high sampling frequency is used for faster signal processing capability can be processed.

More detailed descriptions of the circuit operation can be found in: Technical Paper STP 97-10, *Monolithic Magnetic Hall Sensing Using Dynamic Quadrature Offset Cancellation* and Technical Paper STP 99-1, *Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator*.



#### Operation

The output of the A3212 switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point  $B_{OPS}$  (or is less than  $B_{OPN}$ ). After turn-on, the output is capable of sinking up to 1 mA and the output voltage is  $V_{OUT(ON)}$ . When the magnetic field is reduced below the release point  $B_{RPS}$  (or increased above  $B_{RPN}$ ), the device output switches high (turns off). The difference in the magnetic operate and release points is the hysteresis ( $B_{hys}$ ) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise. The A3211 functions in the same manner, except the output voltage is reversed from the A3212, as shown in the figures to the right.

As used here, negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.

#### **Applications**

Allegro's pole-independent processing technique allows for operation with either a north pole or south pole magnet orientation, enhancing the manufacturability of the device. The state-of-the-art technology provides the same output polarity for either pole face.

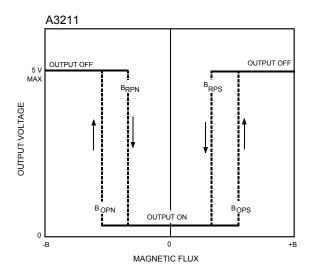
It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper-stabilization technique. This is especially true due to the relatively high impedance of battery supplies.

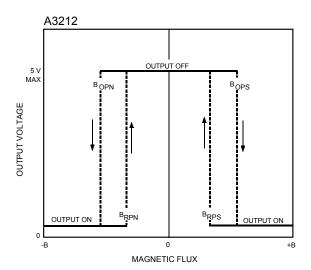
The simplest form of magnet that will operate these devices is a bar magnet with either pole near the branded surface of the device. Many other methods of operation are possible. Extensive applications information for Hall-effect devices is available in:

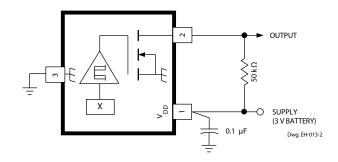
- Hall-Effect IC Applications Guide, Application Note 27701;
- Hall-Effect Devices: Guidelines for Designing Subassemblies Using Hall-Effect Devices, Application Note 27703.1;
- Soldering Methods for Allegro's Products SMD and Through-Hole, Application Note 26009.

All are provided at

www.allegromicro.com









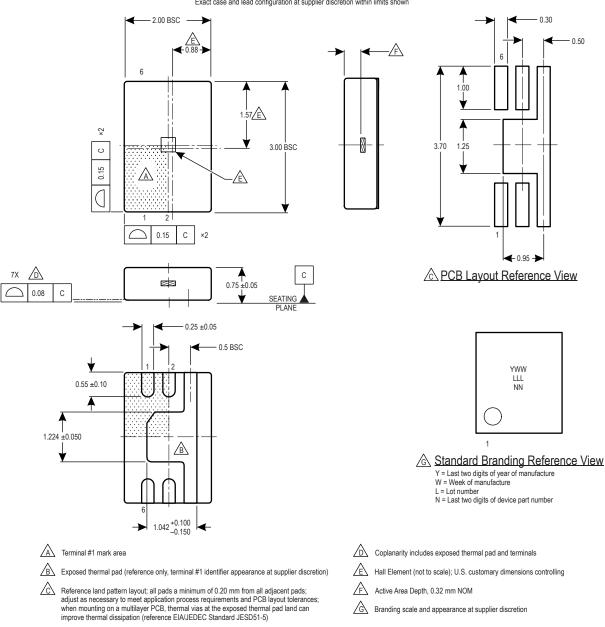
#### PACKAGE OUTLINE DRAWINGS

For Reference Only — Not for Tooling Use

(Reference Allegro DWG-0000373)

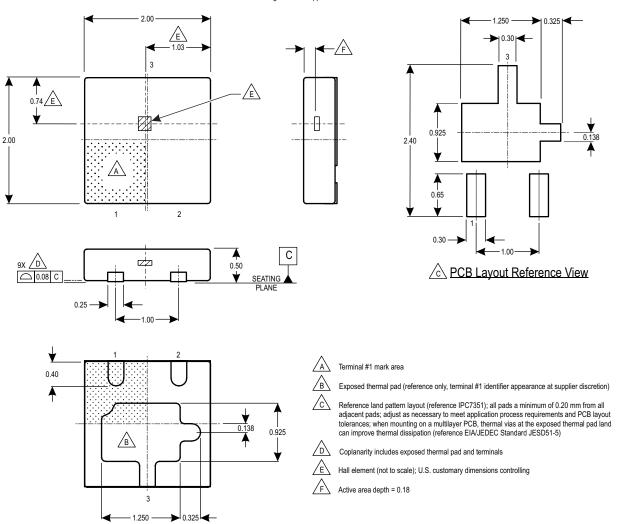
Dimensions in millimeters — NOT TO SCALE

Exact case and lead configuration at supplier discretion within limits shown



Package EH, 6-Pin DFN

For Reference Only — Not for Tooling Use
(Reference DWG-2861 and JEDEC MO-229UCCD)
All dimension nominal – Dimensions in millimeters – NOT TO SCALE
Exact case and lead configuration at supplier discretion within limits shown



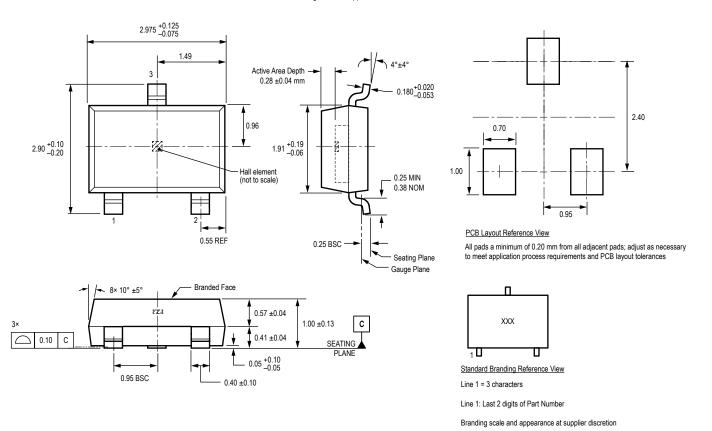
Package EL, 3-Pin DFN



## For Reference Only – Not for Tooling Use (Reference Allegro DWG-0000628, Rev. 1) NOT TO SCALE

Dimensions in millimeters

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions Exact case and lead configuration at supplier discretion within limits shown

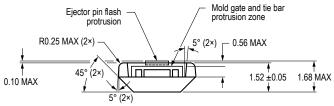


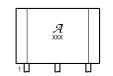
Package LH, 3-Pin SOT-23W

#### For Reference Only - Not For Tooling Use

(Reference DWG-0000404, Rev. 1) NOT TO SCALE Dimensions in millimeters

Exact case and lead configuration at supplier discretion within limits shown



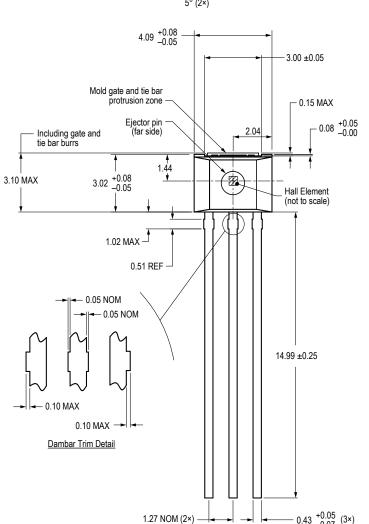


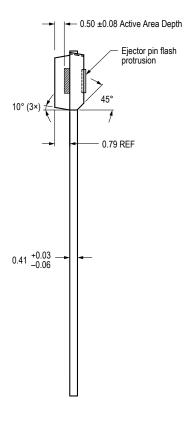
Standard Branding Reference View

Line 1,2 = 3 characters

Line 1: Logo A Line 2: Last 3 digits of Part Number

Branding scale and appearance at supplier discretion





Package UA, 3-Pin SIP

# A3211 and A3212

### **Micropower Ultrasensitive Hall-Effect Switches**

#### **Revision History**

| Number | Date               | Description  |
|--------|--------------------|--|
| 18     | December 11, 2013  | Update application note references   |
| 19     | August 1, 2014     | Revised footnote on Selection Guide  |
| 20     | January 1, 2015    | Added LX option to Selection Guide   |
| 21     | September 22, 2015 | Corrected LH package Active Area Depth value; added AEC-Q100 qualification under Features and Benefits |
| 22     | December 1, 2015   | Updated product status in Selection Guide and footnotes  |
| 23     | December 5, 2016   | Updated product status in Selection Guide and footnotes  |
| 24     | February 27, 2017  | Minor editorial updates  |
| 25     | February 19, 2019  | Minor editorial updates  |
| 26     | February 24, 2020  | Minor editorial updates  |
| 27     | February 16, 2022  | Updated package drawings (pages 9, 11-12)  |

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